

EXPRESS MAIL LABEL NO.: EV627625908US

Form PTO-1749

Sheet 1 of 2

Applicant: David Craig Smith, et al.

Serial No.: 10/827,153

Att'y Docket No.: 14374.100

Filing Date: April 19, 2004

Group: 2882

Confirmation No.: 2677

For: HIGH VOLTAGE CONNECTOR FOR X-RAY TUBE

INFORMATION DISCLOSURE CITATIONS MADE BY APPLICANT

U.S. Patent Documents

Examiner Initial*	Patent Number	Issue Date	Name	Class/Sub
CT 1	4,412,938	11/01/1983	Kakizaki et al.	252/ 511
2	4,618,977	10/1986	Brettschneider et al.	378/ 139
3	4,685,118	08/1987	Furbee et al.	378/ 114
4	4,738,798	04/19/1988	Mahler	252/62.3Q
5	4,774,137	09/27,1988	Alberts et al.	428/407
6	5,238,607	08/24/1993	Herron et al.	252/519.34
7	5,340,500	08/23/1994	Chao et al.	252/500
8	5,515,413	05/1996	Knudsen et al.	378 /136
9	5,556,716	09/17/1996	Herron et al.	428 /688
10	5,866,252	02/02/1999	de Rochemont et al.	428 /373
11	6,148,061	11/14/2000	Shefer et al.	378/121
12	6,195,411 B1	02/2001	Dinsmore	378 /65

Examiner:

Courtney Thomas

Date Considered: 10.27.05

*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

EXPRESS MAIL LABEL NO.: EV627625908US

Form PTO-1449

Sheet 2 of 2

Applicant: David Craig Smith, et al.

Serial No.: 10/827,153

Att'y Docket No.: 14374.100

Filing Date: April 19, 2004

Group: 2882

Confirmation No.: 2677

For: HIGH VOLTAGE CONNECTOR FOR X-RAY TUBE

Other Documents

(including author, title, pertinent pages, etc.)

Examiner

Initial*

CT 13 Article entitled "*Multilayer High Gradient Insulator Technology*," IEEE Transactions on Dielectrics and Electrical Insulation, Vol. 7, No. 3, June 2000, pgs. 334-339; by S.E. Sampayan, P.A. Vitello, M. L. Krogh and J. M. Elizondo.

Examiner:

Courtney Thomas

Date Considered: 10.27.05

*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.